TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74VCXHR162652FT

Low-Voltage 16-Bit Bus Transceiver/Register with Bushold

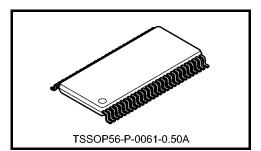
The TC74VCXHR162652FT is a high-performance CMOS 16-bit bus transceiver/register. Designed for use in 1.8-V, 2.5-V or 3.3-V systems, it achieves high-speed operation while maintaining the CMOS low power dissipation.

This device is bus transceiver with 3-state outputs, D-type flip-flops, and control circuitry arranged for multiplexed transmission of data directly from the internal registers.

The $26\text{-}\Omega$ series resistor helps reducing output overshoot and undershoot without external resistor.

The A, B data inputs include active bushold circuitry, eliminating the need for external pull-up resistors to hold unused or floating data inputs at a valid logic level.

All inputs are equipped with protection circuits against static discharge.



Weight: 0.25 g (typ.)

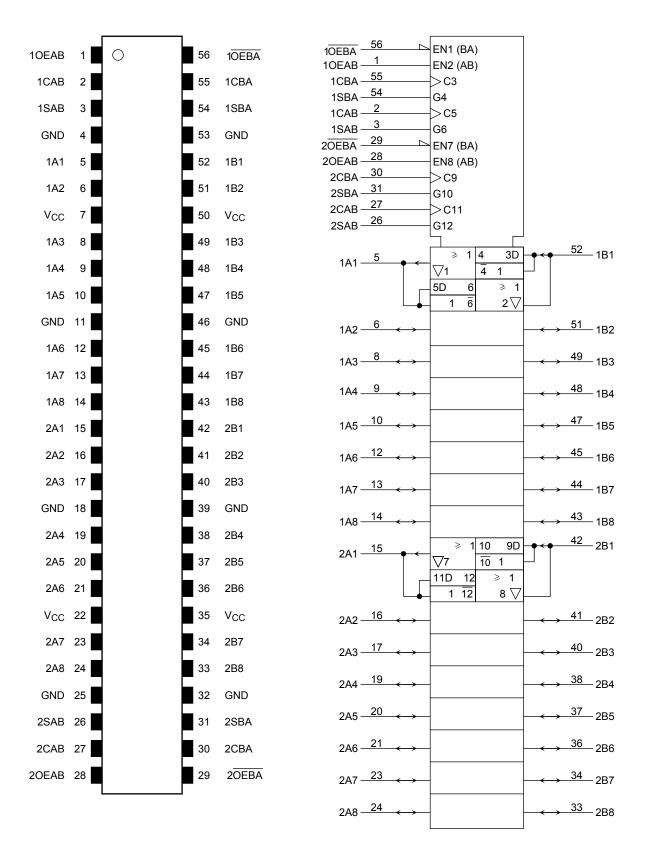
Features (Note)

- 26-Ω series resistors on outputs
- Low-voltage operation: VCC = 1.8 to 3.6 V
- Bushold on data inputs eliminating the need for external pull-up/pull-down resistors
- High-speed operation: $t_{pd} = 3.8 \text{ ns (max)} (V_{CC} = 3.0 \text{ to } 3.6 \text{ V})$
 - $t_{pd} = 4.9 \text{ ns (max) (VCC} = 2.3 \text{ to } 2.7 \text{ V)}$
 - $t_{pd} = 9.8 \text{ ns (max) (VCC} = 1.8 \text{ V)}$
- 3.6-V tolerant control inputs
- Output current: $I_{OH}/I_{OL} = \pm 12 \text{ mA (min)} (V_{CC} = 3.0 \text{ V})$
 - : $I_{OH}/I_{OL} = \pm 8 \text{ mA (min) (V}_{CC} = 2.3 \text{ V)}$
 - $: I_{OH}/I_{OL} = \pm 4 \text{ mA (min) (V}_{CC} = 1.8 \text{ V)}$
- Latch-up performance: -300 mA
- ESD performance: Machine model $\geq \pm 200 \text{ V}$
 - Human body model ≥ ±2000 V
- Package: TSSOP

Note: Do not apply a signal to any bus pins when it is in the output mode. Damage may result.

Pin Assignment (top view)

IEC Logic Symbol





Truth Table

		Contro	I Inputs			В	us	Function			
OEAB	OEBA	CAB	CBA	SAB	SBA	Α	В	Function			
		X*	X*	Х	Х	Input	Input	The output functions of A and B Busses are			
L	Н	^	^	^	^	Z	Z	disabled.			
L	11			X	х	х	X	Both A and B Busses are used as inputs to the internal flip-flops. Data on the Bus will be stored on the rising edge of the Clock.			
						Input	Output				
		X*	X*	L	X	L	L	The data on the A bus are displayed on the B bus.			
						Н	Н				
		_	X*	L	X	L	L	The data on the A bus are displayed on the B Bus, and are stored into the A storage			
Н	Н		^.	L	^	Н	Н	flip-flops on the rising edge of CAB.			
		X*	X*	Н	х	Х	Qn	The data in the A storage flop-flops are displayed on the B Bus.			
						L	L	The data on the A Bus are stored into the A			
			X*	Н			storage flip-flops on the rising edge of CAB, and the stored data propagate directly onto the B Bus.				
					L	Output	Input				
		X*	X*	X		L	L	L	L	L	L
						Н	Н				
		X*	←	X		L	L	The data on the B Bus are displayed on the			
L	L	Λ.		^	L	Н	Н	A Bus, and are stored into the B storage flip-flops on the rising edge of CBA.			
		X*	X*	х	Н	Qn	х	The data in the B storage flip-flops are displayed on the A Bus.			
			_			L	L	The data on the B Bus are stored into the B			
		X*		Х	Н	н	Н	storage flip-flops on the rising edge of CBA, and the stored data propagate directly onto the A Bus.			
						Output	Output				
н	L	X*	X*	н	н	Qn	Qn	The data in the A storage flop-flops are displayed on the B Bus, and the data in the B storage flop-flops are displayed on the A.			

X: Don't care

Z: High impedance

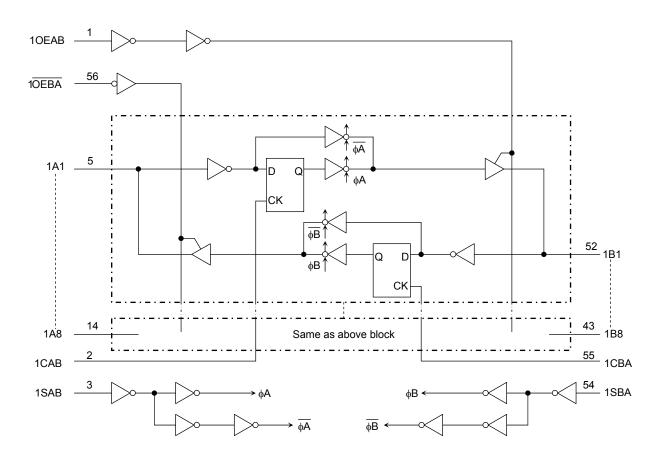
Qn: The data stored into the internal flip-flops by most recent low to high transition of the clock inputs.

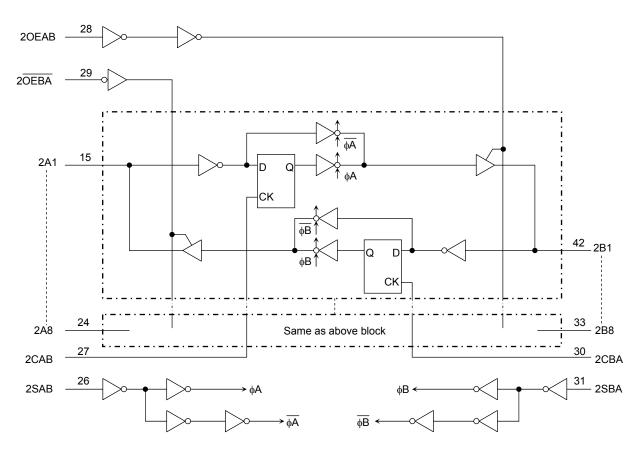
3

*: The clocks are not internally gated with either OEAB or OEBA.

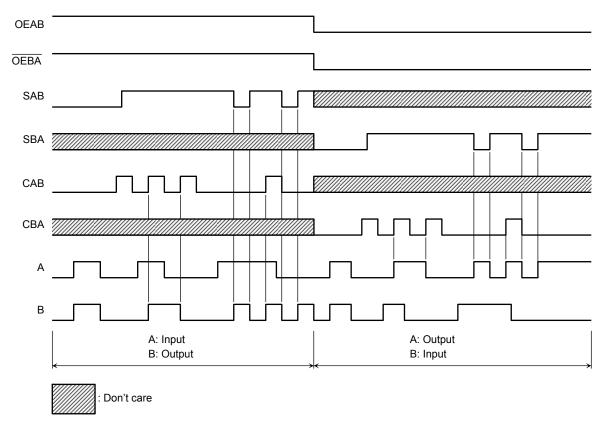
Therefore, data on the A and/or B busses may be clocked into the storage flip-flops at any time.

System Diagram





Timing Chart



Absolute Maximum Ratings (Note 1)

Characteristics		Symbol	Rating	Unit
Power sup	pply voltage	V_{CC}	-0.5 to 4.6	V
DC input	(OEAB, OEBA, SAB, SBA, CAB, CBA)		-0.5 to 4.6	.,
voltage	(An, Bn)	V _{IN}	-0.5 to $V_{CC} + 0.5$	V
	(*, =)		(Note 2)	
DC output voltage	(An, Bn)	V _{OUT}	-0.5 to V _{CC} + 0.5 (Note 3)	>
Input diode	e current	l _{IK}	-50	mA
Output dio	de current	I _{OK}	±50 (Note 4)	mA
Output current		lout	±50	mA
Power dissipation		P_{D}	400	mW
DC V _{CC} /ground current per supply pin		I _{CC} /I _{GND}	±100	mA
Storage te	mperature	T _{stg}	-65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

5

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: OFF state

Note 3: High or low state. IOUT absolute maximum rating must be observed.

Note 4: $V_{OUT} < GND$, $V_{OUT} > V_{CC}$



Operating Ranges (Note 1) (Note 2)

Characteristics		Symbol	Rating	Unit	
Power sur	oply voltage	V _{CC}	1.8 to 3.6	V	
rower su	oply voltage	v CC	1.2 to 3.6 (Note 3)	V	
Input voltage	(OEAB, OEBA, SAB, SBA, CAB, CBA)	V _{IN}	-0.3 to 3.6	V	
voitage	(An, Bn)		0 to V _{CC} (Note 4)		
Output voltage	(An, Bn)	V _{OUT}	0 to V _{CC} (Note 5)	٧	
			±12 (Note 6)		
Output cu	Output current		±8 (Note 7)	mA	
			±4 (Note 8)		
Operating temperature		T _{opr}	-40 to 85	°C	
Input rise	and fall time	dt/dv	0 to 10 (Note 9)	ns/V	

- Note 1: The operating ranges must be maintained to ensure the normal operation of the device.

 Unused inputs must be tied to either VCC or GND.
- Note 2: Floating or unused control inputs must be held high or low.
- Note 3: Data retention only
- Note 4: OFF state
- Note 5: High or low state
- Note 6: $V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$
- Note 7: $V_{CC} = 2.3 \text{ to } 2.7 \text{ V}$
- Note 8: $V_{CC} = 1.8 \text{ V}$
- Note 9: $V_{IN} = 0.8$ to 2.0 V, $V_{CC} = 3.0$ V

6



Electrical Characteristics

DC Characteristics (Ta = -40 to 85°C, 2.7 V < V_{CC} \leq 3.6 V)

Characteristics		Symbol	Symbol Test Condition			Min	Max	Unit
0.10.1011	7.1.00	Cy20.			V _{CC} (V)		1116.71	0
Input voltage	H-level	V _{IH}	-	_	2.7 to 3.6	2.0	_	V
input voitage	L-level	V _{IL}	-	_	2.7 to 3.6	_	0.8	V
				I _{OH} = -100 μA	2.7 to 3.6	V _{CC} - 0.2	_	
	H-level	V _{OH}	V _{IN} = V _{IH} or V _{IL}	$I_{OH} = -6 \text{ mA}$	2.7	2.2	_	
				$I_{OH} = -8 \text{ mA}$	3.0	2.4	_	
Output voltage				$I_{OH} = -12 \text{ mA}$	3.0	2.2	_	V
				$I_{OL} = 100 \mu A$	2.7 to 3.6	_	0.2	
	L-level	V _{OL}	$V_{IN} = V_{IH}$ or V_{IL}	I _{OL} = 6 mA	2.7	_	0.4	
	L-ievei			I _{OL} = 8 mA	3.0	_	0.5	
				I _{OL} = 12 mA	3.0	_	0.8	
Input leakage currer (OEAB, OEBA, SA CAB, CBA)		I _{IN}	V _{IN} = 0 to 3.6 V		2.7 to 3.6	_	±5.0	μА
Bushold input minim	num drive		V _{IN} = 0.8 V		3.0	75	_	
hold current		I (HOLD)	V _{IN} = 2.0 V	3.0	-75	_	μΑ	
Bushold input over-drive current to change state				(Note 1)	3.6		450	^
		I _I (OD)		(Note 2)	3.6	_	-450	μА
3-state output OFF state current		l _{OZ}	$V_{IN} = V_{IH}$ or V_{IL} $V_{OUT} = V_{CC}$ or GND		2.7 to 3.6	_	±10.0	μА
Quiescent supply cu	ırrent	Icc	V _{IN} = V _{CC} or GND		2.7 to 3.6	_	20.0	μΑ
Increase in I _{CC} per	input	Δlcc	$V_{IH} = V_{CC} - 0.6 V$		2.7 to 3.6		750	μА

Note 1: An external driver must source at least the specified current to switch from LOW-to-HIGH.

Note 2: An external driver must sink at least the specified current to switch from HIGH-to-LOW.



DC Characteristics (Ta = -40 to 85°C, 2.3 V \leq V_{CC} \leq 2.7 V)

Characteristics		Symbol	Test C	ondition		Min	Max	Unit
	1				V _{CC} (V)			
Input voltage	H-level	V _{IH}	-	_	2.3 to 2.7	1.6	_	V
put voltago	L-level	V_{IL}	-	_	2.3 to 2.7		0.7	·
				I _{OH} = -100 μA	2.3 to 2.7	V _{CC} - 0.2	_	
	H-level	V _{OH}	V _{IN} = V _{IH} or V _{IL}	$I_{OH} = -4 \text{ mA}$	2.3	2.0	_	
				I _{OH} = -6 mA	2.3	1.8	_	
Output voltage				$I_{OH} = -8 \text{ mA}$	2.3	1.7	_	V
	L-level		$V_{IN} = V_{IH}$ or V_{IL}	$I_{OL} = 100 \mu A$	2.3 to 2.7	_	0.2	
		V _{OL}		I _{OL} = 6 mA	2.3	_	0.4	
				I _{OL} = 8 mA	2.3	_	0.6	
Input leakage currer	nt							
(OEAB, OEBA, SA CAB, CBA)	AB, SBA,	I _{IN}	V _{IN} = 0 to 3.6 V		2.3 to 2.7	_	±5.0	μΑ
Bushold input minim	num drive		V _{IN} = 0.7 V		2.3	45	_	^
hold current		I (HOLD)	V _{IN} = 1.6 V		2.3	-45	_	μΑ
Bushold input over-drive current to change state				(Note 1)	2.7		300	^
		I _I (OD)		(Note 2)	2.7		-300	μА
		loz	$V_{IN} = V_{IH}$ or V_{IL} $V_{OUT} = V_{CC}$ or GND		0.04-0.7		140.0	
3-state output OFF s	3-state output OFF state current				2.3 to 2.7	_	±10.0	μА
Quiescent supply cu	ırrent	Icc	V _{IN} = V _{CC} or GND		2.3 to 2.7		20.0	μА

Note 1: An external driver must source at least the specified current to switch from LOW-to-HIGH.

Note 2: An external driver must sink at least the specified current to switch from HIGH-to-LOW.



DC Characteristics (Ta = -40 to 85°C, 1.8 V \leq V_{CC} < 2.3 V)

Characteristics		Symbol	Test Condition		V _{CC} (V)	Min	Max	Unit
Input voltage	H-level	V _{IH}	_		1.8 to 2.3	0.7 × V _{CC}	_	V
mput voltage	L-level	V _{IL}	-	_	1.8 to 2.3		0.2 × V _{CC}	V
	H-level	V _{OH}	V _{IN} = V _{IH} or V _{IL}	I _{OH} = -100 μA	1.8	V _{CC} - 0.2	ı	
Output voltage				$I_{OH} = -4 \text{ mA}$	1.8	1.4	_	V
	L-level	V _{OL}	V _{IN} = V _{IH} or V _{IL}	I _{OL} = 100 μA	1.8	_	0.2	
				I _{OL} = 4 mA	1.8	_	0.3	
Input leakage current (OEAB, OEBA, SAB, SBA, CAB, CBA)		I _{IN}	V _{IN} = 0 to 3.6 V		1.8	_	±5.0	μА
Bushold input minim	num drive	l _{I (HOLD)}	V _{IN} = 0.36 V		1.8	25		^
hold current			V _{IN} = 1.26 V		1.8	-25	_	μА
Bushold input over-drive current to change state		li (an)		(Note 1)	1.8	_	200	^
		I _I (OD)	(Note 2)		1.8	_	-200	μА
3-state output OFF state current		I _{OZ}	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $V_{OUT} = V_{CC} \text{ or GND}$		1.8		±10.0	μА
Quiescent supply cu	ırrent	Icc	V _{IN} = V _{CC} or GND		1.8		20.0	μΑ

Note 1: An external driver must source at least the specified current to switch from LOW-to-HIGH.

Note 2: An external driver must sink at least the specified current to switch from HIGH-to-LOW.



AC Characteristics (Ta = –40 to 85°C, input: $t_r = t_f$ = 2.0 ns, C_L = 30 pF, R_L = 500 Ω) (Note 1)

Characteristics	Symbol	Test Condition	_	Min	Max	Unit
	5,		V _{CC} (V)			
			1.8	100	_	
Maximum clock frequency	f _{max}	Figure 1, Figure 3	2.5 ± 0.2	200	_	MHz
			3.3 ± 0.3	250	_	
Dranagation delay time	4		1.8	1.5	9.8	
Propagation delay time (An, Bn-Bn, An)	t _{pLH}	Figure 1, Figure 2	2.5 ± 0.2	0.8	4.9	ns
(All, Dil-Dil, All)	t _{pHL}		3.3 ± 0.3	0.6	3.8	
Draw a settion delay time	_		1.8	1.5	9.8	
Propagation delay time	t _{pLH}	Figure 1, Figure 3	2.5 ± 0.2	0.8	5.8	ns
(CAB, CBA-Bn, An)	t _{pHL}		3.3 ± 0.3	0.6	4.1	
Draw a settion delay time	_		1.8	1.5	9.8	
Propagation delay time	t _{pLH}	Figure 1, Figure 2	2.5 ± 0.2	0.8	5.8	ns
(SAB, SBA-Bn, An)	t _{pHL}		3.3 ± 0.3	0.6	4.4	
Outside making times		Figure 1, Figure 4, Figure 5	1.8	1.5	9.8	ns
Output enable time	t _{pZL}		2.5 ± 0.2	0.8	5.9	
(OEAB, OEBA -An, Bn)			3.3 ± 0.3	0.6	4.3	
Outrout disable times	1	Figure 1, Figure 4, Figure 5	1.8	1.5	9.4	ns
Output disable time (OEAB, OEBA -An, Bn)	t _{pLZ}		2.5 ± 0.2	0.8	5.2	
(OEAB, OEBA -AII, BII)	t _{pHZ}		3.3 ± 0.3	0.6	4.5	
			1.8	4.0	_	
Minimum pulse width	t _{w (H)}	Figure 1, Figure 3	2.5 ± 0.2	1.5	_	ns
	t _{w (L)}		3.3 ± 0.3	1.5	_	
			1.8	2.5	_	
Minimum setup time	ts	Figure 1, Figure 3	2.5 ± 0.2	1.5	_	ns
			3.3 ± 0.3	1.5	_	
			1.8	1.0	_	
Minimum hold time	t _h	Figure 1, Figure 3	2.5 ± 0.2	1.0	_	ns
			3.3 ± 0.3	1.0	_	
	1.		1.8	_	0.5	ns
Output to output skew	t _{osLH}	(Note 2)	2.5 ± 0.2	_	0.5	
	tosHL		3.3 ± 0.3	_	0.5	

Note 1: For $C_L = 50$ pF, add approximately 300 ps to the AC maximum specification.

Note 2: Parameter guaranteed by design. $(t_{OSLH} = |t_{pLHm} - t_{pLHn}|, t_{OSHL} = |t_{pHLm} - t_{pHLn}|)$



Dynamic Switching Characteristics

(Ta = 25°C, input: $t_r = t_f = 2.0 \text{ ns}, C_L = 30 \text{ pF}, R_L = 500 \Omega$)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Тур.	Unit
		V _{IH} = 1.8 V, V _{IL} = 0 V (Note	1.8	0.15	
Quiet output maximum dynamic V _{OL}	V_{OLP}	$V_{IH} = 2.5 \text{ V}, V_{IL} = 0 \text{ V}$ (Note	2.5	0.25	V
, 01		$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$ (Note	3.3	0.35	
		$V_{IH} = 1.8 \text{ V}, V_{IL} = 0 \text{ V}$ (Note	1.8	-0.15	
Quiet output minimum dynamic V _{OI}	V _{OLV}	$V_{IH} = 2.5 \text{ V}, V_{IL} = 0 \text{ V}$ (Note	2.5	-0.25	V
, 32		$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$ (Note	3.3	-0.35	
		$V_{IH} = 1.8 \text{ V}, V_{IL} = 0 \text{ V}$ (Note	1.8	1.55	V
Quiet output minimum dynamic V _{OH}	V _{OHV}	$V_{IH} = 2.5 \text{ V}, V_{IL} = 0 \text{ V}$ (Note	2.5	2.05	
		$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$ (Note	3.3	2.65	

Note: Parameter guaranteed by design.

Capacitive Characteristics (Ta = 25°C)

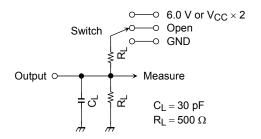
Characteristics	Symbol	Test Condition	V _{CC} (V)	Тур.	Unit
Input capacitance	C _{IN}	(OEAB, OEBA, CAB, CBA, SAB, SBA)	1.8, 2.5, 3.3	6	pF
Bus I/O capacitance	C _{I/O}	An, Bn	1.8, 2.5, 3.3	7	pF
Power dissipation capacitance	C _{PD}	f _{IN} = 10 MHz (Note)	1.8, 2.5, 3.3	20	pF

Note: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/16 \text{ (per bit)}$

AC Test Circuit



Parameter	Switch			
t _{pLH} , t _{pHL}	Open			
t _{pLZ} , t _{pZL}	$ \begin{array}{cccccccccccccccccccccccccccccccccccc$			
t _{pHZ} , t _{pZH}	GND			

Figure 1

AC Waveform

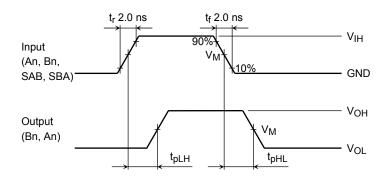


Figure 2 t_{pLH}, t_{pHL}

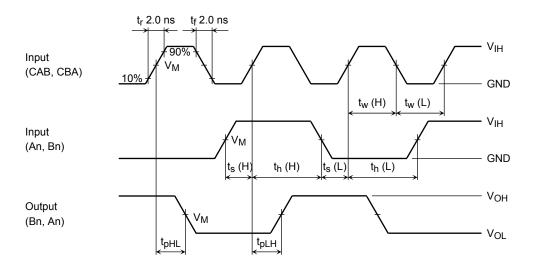


Figure 3 t_{pLH} , t_{pHL} , t_{w} , t_{s} , t_{h}

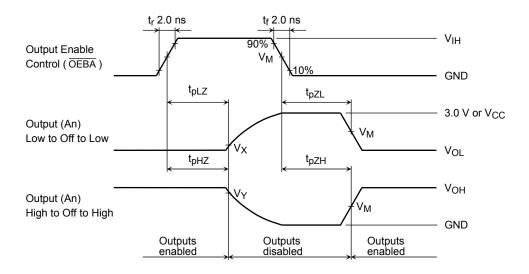


Figure 4 t_{pLZ} , t_{pHZ} , t_{pZL} , t_{pZH}

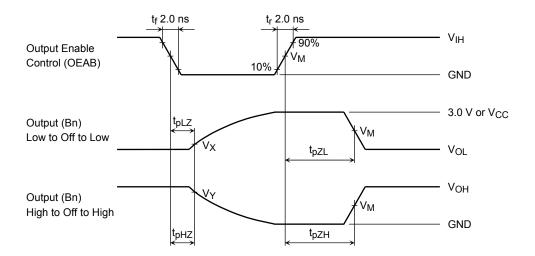
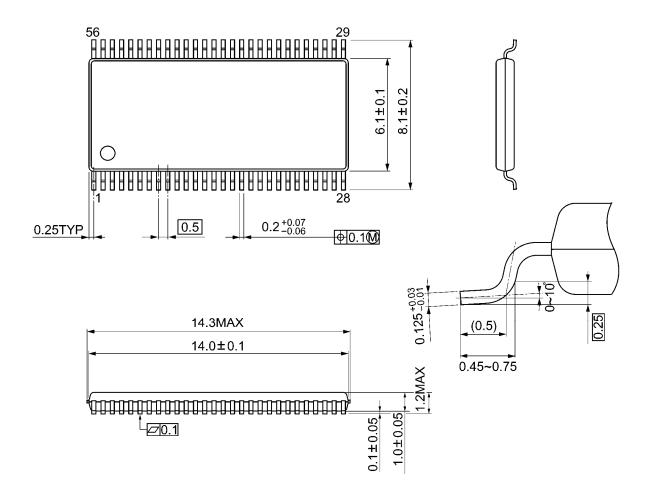


Figure 5 t_{pLZ} , t_{pHZ} , t_{pZL} , t_{pZH}

Symbol		V _{CC}	-
Symbol	$3.3\pm0.3~\textrm{V}$	$2.5\pm0.2\textrm{V}$	1.8 V
V_{IH}	2.7 V	V _{CC}	V _{CC}
V _M	1.5 V	V _{CC} /2	V _{CC} /2
VX	V _{OL} + 0.3 V	V _{OL} + 0.15 V	V _{OL} + 0.15 V
VY	V _{OH} – 0.3 V	V _{OH} – 0.15 V	V _{OH} – 0.15 V

Package Dimensions

TSSOP56-P-0061-0.50A Unit: mm



Weight: 0.25 g (typ.)

RESTRICTIONS ON PRODUCT USE

20070701-EN GENERAL

- The information contained herein is subject to change without notice.
- TOSHIBA is continually working to improve the quality and reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to comply with the standards of safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such TOSHIBA products could cause loss of human life, bodily injury or damage to property. In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent TOSHIBA products specifications. Also, please keep in mind the precautions and conditions set forth in the "Handling Guide for Semiconductor Devices," or "TOSHIBA Semiconductor Reliability Handbook" etc.
- The TOSHIBA products listed in this document are intended for usage in general electronics applications (computer, personal equipment, office equipment, measuring equipment, industrial robotics, domestic appliances, etc.). These TOSHIBA products are neither intended nor warranted for usage in equipment that requires extraordinarily high quality and/or reliability or a malfunction or failure of which may cause loss of human life or bodily injury ("Unintended Usage"). Unintended Usage include atomic energy control instruments, airplane or spaceship instruments, transportation instruments, traffic signal instruments, combustion control instruments, medical instruments, all types of safety devices, etc.. Unintended Usage of TOSHIBA products listed in his document shall be made at the customer's own risk.
- The products described in this document shall not be used or embedded to any downstream products of which manufacture, use and/or sale are prohibited under any applicable laws and regulations.
- The information contained herein is presented only as a guide for the applications of our products. No responsibility is assumed by TOSHIBA for any infringements of patents or other rights of the third parties which may result from its use. No license is granted by implication or otherwise under any patents or other rights of TOSHIBA or the third parties.
- Please contact your sales representative for product-by-product details in this document regarding RoHS
 compatibility. Please use these products in this document in compliance with all applicable laws and regulations
 that regulate the inclusion or use of controlled substances. Toshiba assumes no liability for damage or losses
 occurring as a result of noncompliance with applicable laws and regulations.